



Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

General Description

The MAX4130–MAX4134 family of operational amplifiers combines 10MHz gain-bandwidth product and excellent DC accuracy with Rail-to-Rail® operation at the inputs and outputs. These devices require only 900µA per amplifier, and operate from either a single supply (+2.7V to +6.5V) or dual supplies ($\pm 1.35\text{V}$ to $\pm 3.25\text{V}$) with a common-mode voltage range that extends 250mV beyond V_{EE} and V_{CC} . They are capable of driving 250Ω loads and are unity-gain stable. In addition, the MAX4131/ MAX4133 feature a shutdown mode in which the outputs are placed in a high-impedance state and the supply current is reduced to only 25µA per amplifier.

With their rail-to-rail input common-mode range and output swing, the MAX4130–MAX4134 are ideal for low-voltage, single-supply operation. Although the minimum operating voltage is specified at 2.7V, the devices typically operate down to 1.8V. In addition, low offset voltage and high speed make them the ideal signal-conditioning stages for precision, low-voltage data-acquisition systems. The MAX4130 is offered in the space-saving 5-pin SOT23 package. The MAX4131 is offered in the ultra-small 6-bump, 1mm x 1.5mm chip-scale package (UCSP™).

Selector Guide

PART	AMPS PER PACKAGE	SHUTDOWN MODE	PIN-PACKAGE
MAX4130	1	—	5 SOT23
MAX4131	1	Yes	6 UCSP, 8 µMAX/SO
MAX4132	2	—	8 µMAX/SO
MAX4133	2	Yes	14 SO
MAX4134	4	—	14 SO

Applications

Battery-Powered Instruments
Portable Equipment
Data-Acquisition Systems
Signal Conditioning
Low-Power, Low-Voltage Applications

Pin Configurations appear at end of data sheet.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.
UCSP is a trademark of Maxim Integrated Products, Inc.

Features

- ◆ 6-Bump UCSP (MAX4131)
- ◆ +2.7V to +6.5V Single-Supply Operation
- ◆ Rail-to-Rail Input Common-Mode Voltage Range
- ◆ Rail-to-Rail Output Voltage Swing
- ◆ 10MHz Gain-Bandwidth Product
- ◆ 900µA Quiescent Current per Amplifier
- ◆ 25µA Shutdown Function (MAX4131/MAX4133)
- ◆ 200µV Offset Voltage
- ◆ No Phase Reversal for Overdriven Inputs
- ◆ Drive 250Ω Loads
- ◆ Stable with 160pF Capacitive Loads
- ◆ Unity-Gain Stable

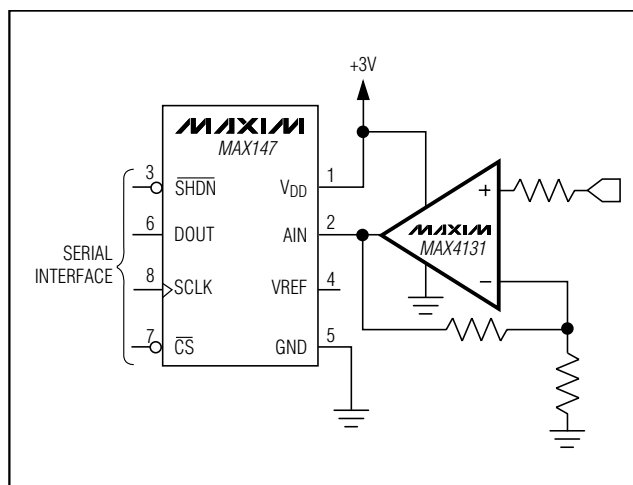
Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4130EUK-T	-40°C to +85°C	5 SOT23-5	AABB
MAX4131C/D	0°C to +70°C	Dice*	—
MAX4131EBT-T	-40°C to +85°C	6 UCSP-6	AAX
MAX4131EUA	-40°C to +85°C	8 µMAX	—
MAX4131ESA	-40°C to +85°C	8 SO	—

*Dice are specified at $T_A = +25^\circ\text{C}$. DC parameters only.

Ordering Information continued at end of data sheet.

Typical Operating Circuit



Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply Rail-to-Rail I/O Op Amps

ABSOLUTE MAXIMUM RATINGS

Supply Voltage ($V_{CC} - V_{EE}$) 7.5V
 $IN+$, $IN-$, $\overline{SHDN}$ Voltage ($V_{CC} + 0.3V$) to ($V_{EE} - 0.3V$)
 Output Short-Circuit Duration (Note 1) Continuous
 (short to either supply)
 Continuous Power Dissipation ($T_A = +70^\circ C$)
 5-Pin SOT23 (derate 7.1mW/ $^\circ C$ above $+70^\circ C$) 571mW
 6-Bump UCSP (derate 2.9mW/ $^\circ C$ above $+70^\circ C$) 308mW
 8-Pin SO (derate 5.88mW/ $^\circ C$ above $+70^\circ C$) 471mW

8-Pin μ MAX (derate 4.10mW/ $^\circ C$ above $+70^\circ C$) 330mW
 14-Pin SO (derate 8.00mW/ $^\circ C$ above $+70^\circ C$) 640mW
 Operating Temperature Range
 MAX413_E_ $-40^\circ C$ to $+85^\circ C$
 Maximum Junction Temperature $+150^\circ C$
 Storage Temperature Range $-65^\circ C$ to $+160^\circ C$
 Lead Temperature (soldering, 10s) $+300^\circ C$
 Bump Reflow Temperature $+235^\circ C$

Note 1: Provided that the maximum package power-dissipation rating is not exceeded.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $V_{CM} = 0V$, $V_{OUT} = V_{CC}/2$, R_L tied to $V_{CC}/2$, $\overline{SHDN} \geq 2V$ (or open), $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Offset Voltage	V_{OS}	$V_{CM} = V_{EE}$ to V_{CC}	MAX4130EUK		± 0.35 ± 1.50	mV
			MAX4131ESA		± 0.20 ± 0.60	
			MAX4131EUA/ MAX4131EBT		± 0.35 ± 1.20	
			MAX4132ESA/ MAX4133ESD		± 0.25 ± 0.75	
			MAX4132EUA		± 0.40 ± 1.50	
			MAX4134ESD		± 0.35 ± 1.50	
Input Bias Current	I_B	$V_{CM} = V_{EE}$ to V_{CC}		± 50	± 150	nA
Input Offset Current	I_{OS}	$V_{CM} = V_{EE}$ to V_{CC}	MAX4131EBT		± 15	nA
			All other packages		± 12	
Differential Input Voltage	R_{IN}	$-1.5V < V_{DIFF} < 1.5V$		500		k Ω
Common-Mode Input Voltage Range	CMVR		$V_{EE} - 0.25$		$V_{CC} - 0.25$	V
Common-Mode Rejection Ratio	CMRR	$V_{EE} - 0.25V < V_{CM} < V_{CC} + 0.25V$	MAX4130EUK		67 90	dB
			MAX4131ESA		78 98	
			MAX4131EUA/ MAX4131EBT		68 88	
			MAX4132ESA/ MAX4133ESD		74 94	
			MAX4132EUA		66 86	
			MAX4134ESD		64 84	
Power-Supply Rejection Ratio	PSRR	$V_{CC} = 2.7V$ to $6.5V$	78	100		dB
Output Resistance	R_{OUT}	$A_V = 1$		0.1		Ω
Off-Leakage Current	I_{LKG}	$\overline{SHDN} < 0.8V$, $V_{OUT} = 0V$ to V_{CC}		± 0.1	± 1	μA

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply Rail-to-Rail I/O Op Amps

DC ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $V_{CM} = 0V$, $V_{OUT} = V_{CC}/2$, R_L tied to $V_{CC}/2$, $\overline{SHDN} \geq 2V$ (or open), $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Large-Signal Voltage Gain	A _V	V _{CC} = 2.7V	V _{OUT} = 0.25V to 2.45V, R _L = 100kΩ		92	108	dB	
			V _{OUT} = 0.4V to 2.3V, R _L = 250Ω		72	82		
		V _{CC} = 5V	V _{OUT} = 0.25V to 4.75V, R _L = 100kΩ		94	108		
			V _{OUT} = 0.4V to 4.6V, R _L = 250Ω		75	86		
Output Voltage Swing	V _O	MAX4130/ MAX4131	R _L = 100kΩ	V _{CC} - V _{OH}		12	20	mV
				V _{OL} - V _{EE}		20	35	
			R _L = 250Ω	V _{CC} - V _{OH}		240	290	
				V _{OL} - V _{EE}		125	170	
		MAX4132/ MAX4133/ MAX4134	R _L = 100kΩ	V _{CC} - V _{OH}		15	30	
				V _{OL} - V _{EE}		25	40	
			R _L = 250Ω	V _{CC} - V _{OH}		280	330	
				V _{OL} - V _{EE}		180	230	
Output Short-Circuit Current	I _{SC}				50		mA	
$\overline{\text{SHDN}}$ Logic Threshold	V _{IL}	MAX4131–MAX4134		Low	0.8		V	
	V _{IH}			High	2.0			
$\overline{\text{SHDN}}$ Input Current	I _{IL}	MAX4131–MAX4134			±1	±3	μA	
Operating Supply Voltage Range	V _{CC}				2.7	6.5	V	
Supply Current per Amplifier	I _{CC}	V _{CM} = V _{OUT} = V _{CC} /2		V _{CC} = 2.7V	900	1050	μA	
				V _{CC} = 5V	1000	1150		
Shutdown Supply Current per Amplifier	I _{SHDN}	$\overline{\text{SHDN}}$ > 0.8V, MAX4131–MAX4134		V _{CC} = 2.7V	25	40	μA	
				V _{CC} = 5V	40	60		

DC ELECTRICAL CHARACTERISTICS

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $V_{CM} = 0V$, $V_{OUT} = V_{CC}/2$, R_L tied to $V_{CC}/2$, $\overline{SHDN} \geq 2V$ (or open), $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Offset Voltage	V_{OS}	$V_{CM} = V_{EE}$ to V_{CC}	MAX4130EUK			± 3.50	mV
			MAX4131ESA			± 0.75	
			MAX4131EUA/MAX4131EBT			± 4.40	
			MAX4132ESA/MAX4133ESD			± 0.95	
			MAX4132EUA			± 4.70	
			MAX4134ESD			± 4.00	
Input Offset Voltage Tempco	TCV_{OS}			± 2			$\mu V/^\circ C$
Input Bias Current	I_B	$V_{CM} = V_{EE}$ to V_{CC}				± 160	nA

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply Rail-to-Rail I/O Op Amps

DC ELECTRICAL CHARACTERISTICS

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $V_{CM} = 0V$, $V_{OUT} = V_{CC}/2$, R_L tied to $V_{CC}/2$, $\overline{SHDN} \geq 2V$ (or open), $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Offset Current	I_{OS}	$V_{CM} = V_{EE}$ to V_{CC}	MAX4131EBT			± 24	nA
			All other packages			± 18	
Common-Mode Input Voltage Range	CMVR			$V_{EE} - 0.20$		$V_{CC} - 0.20$	V
Common-Mode Rejection Ratio	CMRR	$V_{EE} - 0.2V < V_{CM} < V_{CC} + 0.2V$	MAX4130EUK		62		dB
			MAX4131ESA		76		
			MAX4131EUA/MAX4131EBT		60		
			MAX4132ESA/MAX4133ESD		74		
			MAX4132EUA		58		
			MAX4134ESD		60		
Power-Supply Rejection Ratio	PSRR	$V_{CC} = 2.7V$ to $6.5V$		74			dB
Off-Leakage Current	I_{LKG}	$\overline{SHDN} < 0.8V$, $V_{OUT} = 0V$ to V_{CC}				± 12	μA
Large-Signal Voltage Gain	A_V	$V_{CC} = 2.7V$	$V_{OUT} = 0.25V$ to $2.45V$, $R_L = 100k\Omega$	84			dB
			$V_{OUT} = 0.4V$ to $2.3V$, $R_L = 250\Omega$	66			
		$V_{CC} = 5V$	$V_{OUT} = 0.25V$ to $4.75V$, $R_L = 100k\Omega$	86			
			$V_{OUT} = 0.4V$ to $4.6V$, $R_L = 250\Omega$	68			
Output Voltage Swing	V_O	MAX4130/ MAX4131ESA/ MAX4131EUA	$R_L = 100k\Omega$	$V_{CC} - V_{OH}$		25	mV
				$V_{OL} - V_{EE}$		40	
			$R_L = 250\Omega$	$V_{CC} - V_{OH}$		300	
				$V_{OL} - V_{EE}$		190	
		MAX4131EBT	$R_L = 100k\Omega$	$V_{CC} - V_{OH}$		25	
				$V_{OL} - V_{EE}$		40	
			$R_L = 250\Omega$	$V_{CC} - V_{OH}$		350	
				$V_{OL} - V_{EE}$		190	
		MAX4132/ MAX4133/ MAX4134	$R_L = 100k\Omega$	$V_{CC} - V_{OH}$		35	
				$V_{OL} - V_{EE}$		50	
			$R_L = 250\Omega$	$V_{CC} - V_{OH}$		350	
				$V_{OL} - V_{EE}$		250	

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply Rail-to-Rail I/O Op Amps

DC ELECTRICAL CHARACTERISTICS (continued)

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $V_{CM} = 0V$, $V_{OUT} = V_{CC}/2$, R_L tied to $V_{CC}/2$, $\overline{SHDN} \geq 2V$ (or open), $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
$\overline{SHDN}$ Logic Threshold	V_{IL}	MAX4131-MAX4134	Low			0.8	V
	V_{IH}		High	2.0			
$\overline{SHDN}$ Input Current	I_{IL}	MAX4131-MAX4134				± 3	μA
Operating Supply Voltage Range	V_{CC}			2.7		6.5	V
Supply Current per Amplifier	I_{CC}	$V_{CM} = V_{OUT} = V_{CC}/2$	MAX4131EBT	$V_{CC} = 2.7V$		1200	μA
				$V_{CC} = 5V$		1350	
		All other devices		$V_{CC} = 2.7V$		1100	
				$V_{CC} = 5V$		1200	
Shutdown Supply Current per Amplifier	I_{SHDN}	$\overline{SHDN} > 0.8V$, MAX4131-MAX4134		$V_{CC} = 2.7V$		50	μA
				$V_{CC} = 5V$		70	

Note 2: All devices are 100% tested at $T_A = +25^\circ C$. MAX4130EUK/MAX4131EBT temperature limits are guaranteed by design.

AC ELECTRICAL CHARACTERISTICS

($V_{CC} = +2.7V$ to $+6.5V$, $V_{EE} = 0V$, $\overline{SHDN} \geq 2V$ (or open), $T_A = +25^\circ C$, unless otherwise noted.)

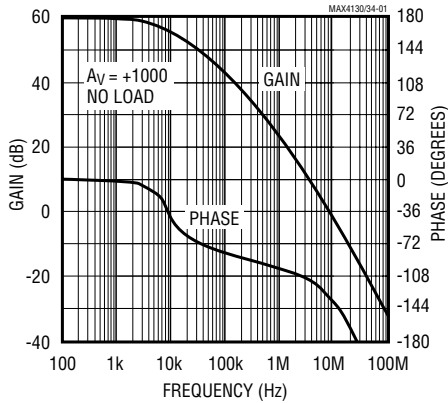
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Gain-Bandwidth Product	GBWP				10		MHz
Phase Margin	θ_M				62		Degrees
Gain Margin	G_M				12		dB
Total Harmonic Distortion	THD	$f = 10kHz$, $V_{OUT} = 2V_{P-P}$ ($A_V = 1$)			0.003		%
Slew Rate	SR				4		V/ μs
Settling Time to 0.01%	t_s	$A_V = 1$, $V_{OUT} = 2V$ step			2.0		μs
Turn-On Time	t_{ON}	$V_{CC} = 0V$ to $3V$ step, $V_{OUT} = V_{CC}/2$			1		μs
$\overline{SHDN}$ Delay		MAX4131-MAX4134, $V_{CC} = 3V$, $V_{OUT} = V_{CC}/2$	Enable		1		μs
			Disable		0.2		
Input Capacitance	C_{IN}				3		pF
Input Noise-Voltage Density	e_n	$f = 1kHz$			22		$nV/\sqrt{Hz}$
Input Noise-Current Density	i_n	$f = 1kHz$			0.4		$pA/\sqrt{Hz}$
Capacitive-Load Stability	C_L	$A_V = 1$			160		pF

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

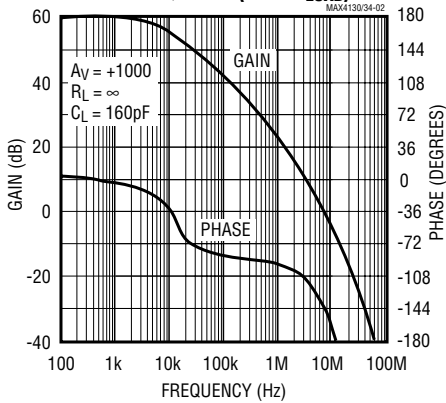
Typical Operating Characteristics

($V_{CC} = +5V$, $V_{EE} = 0V$, $V_{CM} = V_{CC} / 2$, $T_A = +25^\circ C$, unless otherwise noted.)

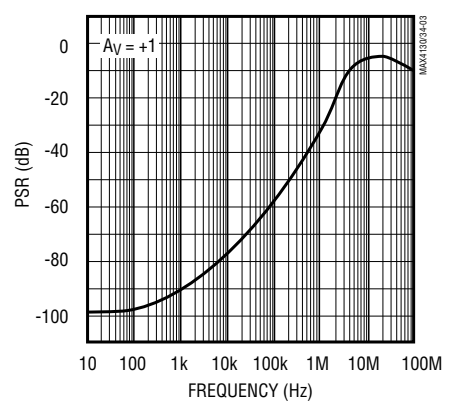
**GAIN AND PHASE
vs. FREQUENCY**



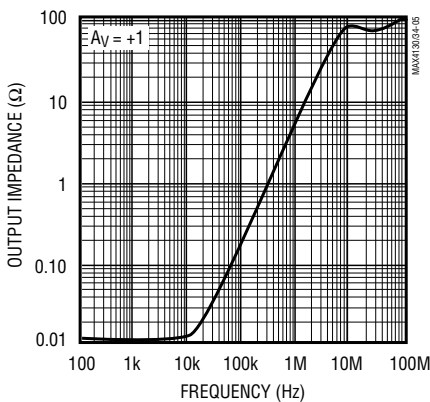
**GAIN AND PHASE
vs. FREQUENCY (WITH CLOAD)**



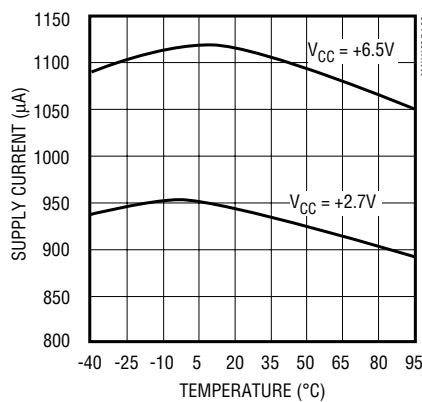
**POWER-SUPPLY REJECTION
vs. FREQUENCY**



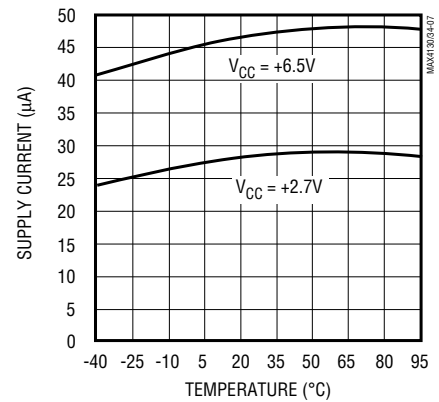
**OUTPUT IMPEDANCE
vs. FREQUENCY**



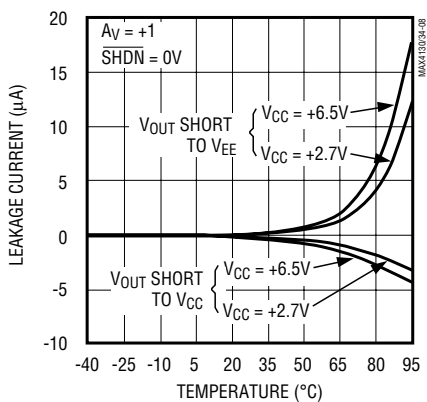
**SUPPLY CURRENT PER AMPLIFIER
vs. TEMPERATURE**



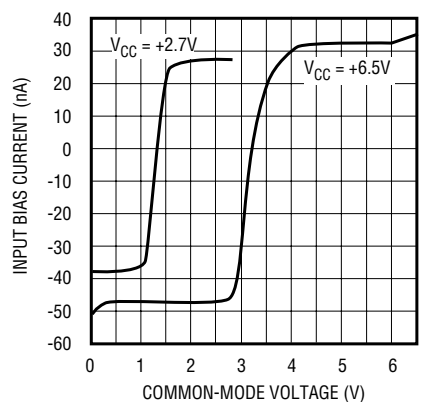
**SHUTDOWN SUPPLY CURRENT
vs. TEMPERATURE**



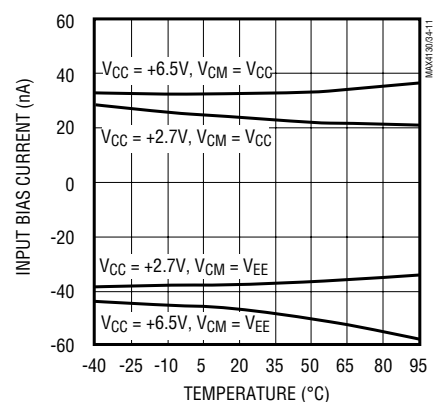
**OUTPUT LEAKAGE CURRENT
vs. TEMPERATURE**



**INPUT BIAS CURRENT
vs. COMMON-MODE VOLTAGE**



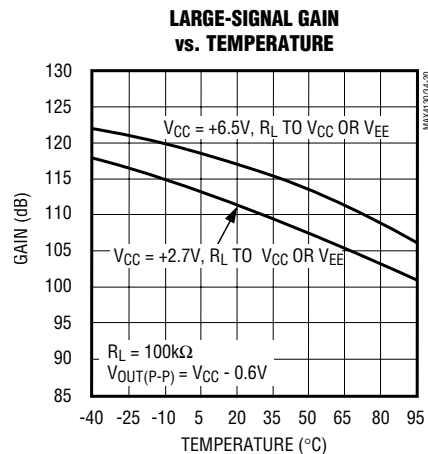
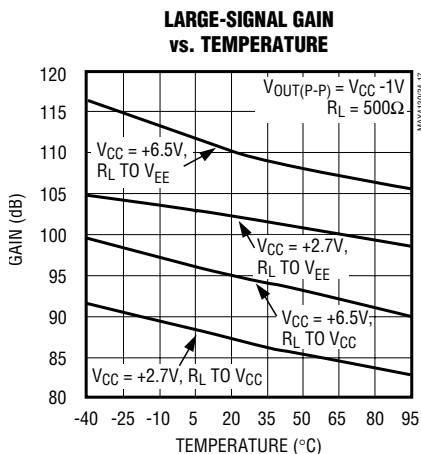
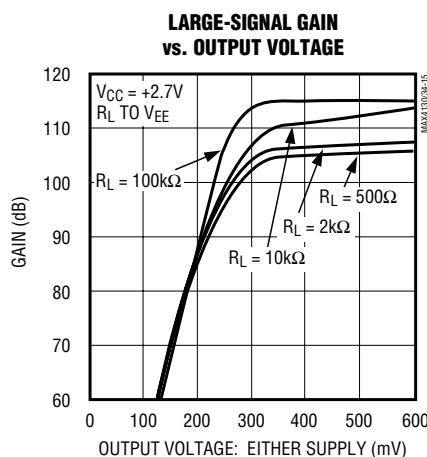
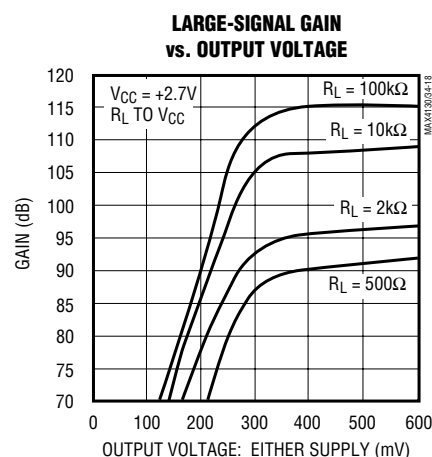
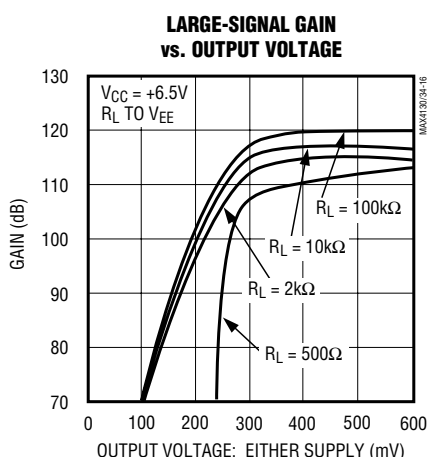
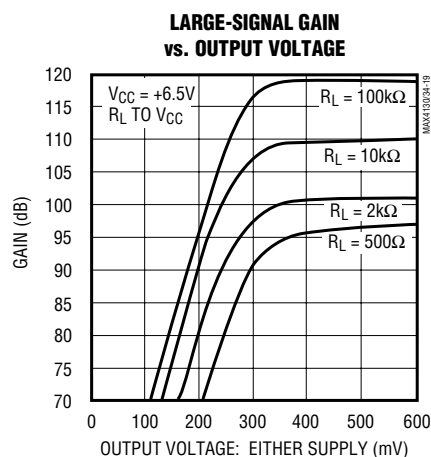
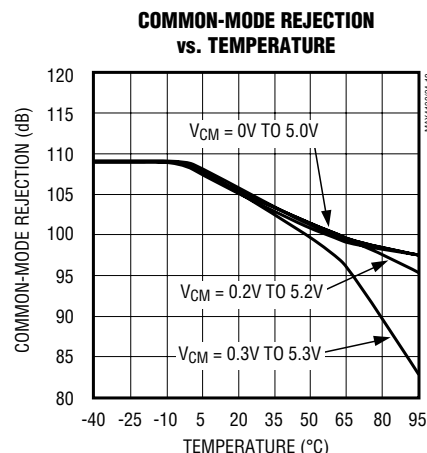
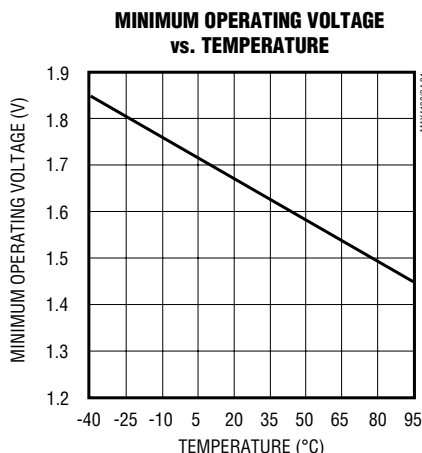
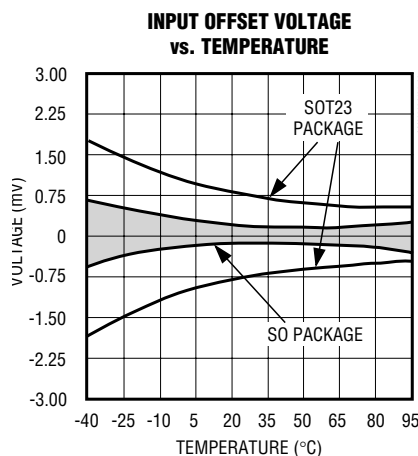
**INPUT BIAS CURRENT
vs. TEMPERATURE**



Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Typical Operating Characteristics (continued)

($V_{CC} = +5V$, $V_{EE} = 0V$, $V_{CM} = V_{CC} / 2$, $T_A = +25^\circ C$, unless otherwise noted.)

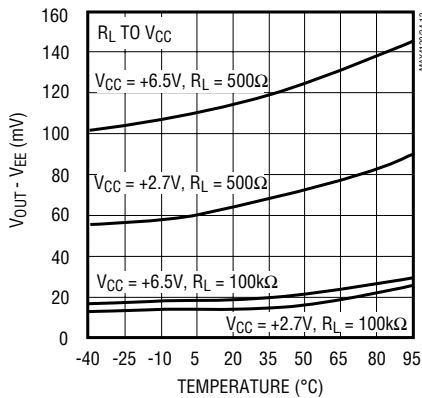


Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

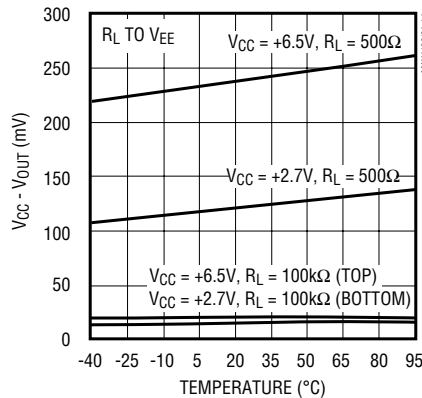
Typical Operating Characteristics (continued)

($V_{CC} = +5V$, $V_{EE} = 0V$, $V_{CM} = V_{CC} / 2$, $T_A = +25^\circ C$, unless otherwise noted.)

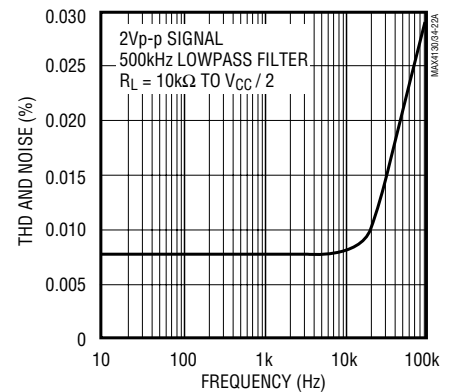
**MINIMUM OUTPUT VOLTAGE
vs. TEMPERATURE**



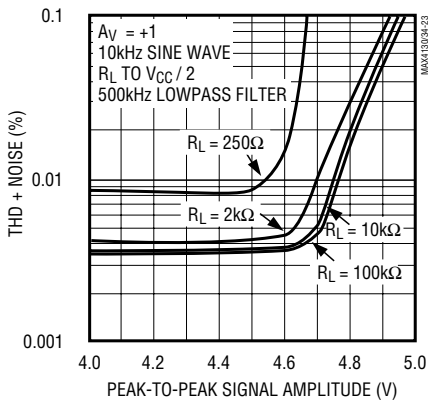
**MAXIMUM OUTPUT VOLTAGE
vs. TEMPERATURE**



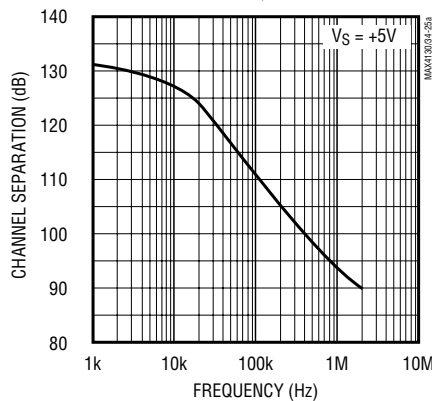
**TOTAL HARMONIC DISTORTION
AND NOISE vs. FREQUENCY**



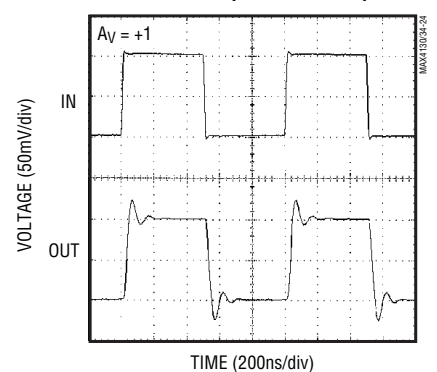
**TOTAL HARMONIC DISTORTION AND NOISE
vs. PEAK-TO-PEAK SIGNAL AMPLITUDE**



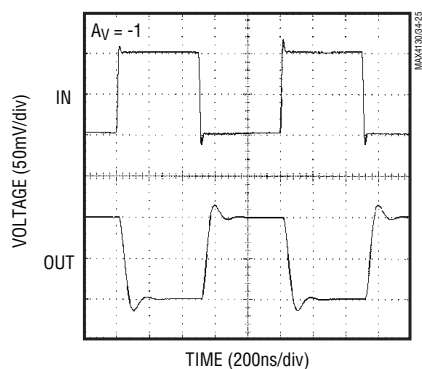
**CHANNEL SEPARATION
vs. FREQUENCY**



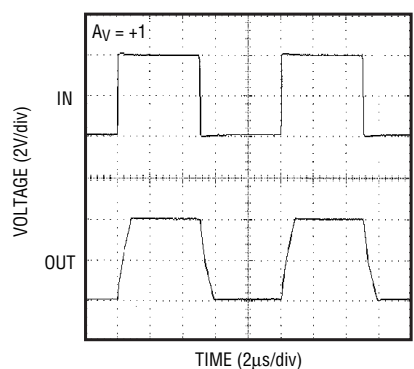
**MAX4131
SMALL-SIGNAL TRANSIENT
RESPONSE (NONINVERTING)**



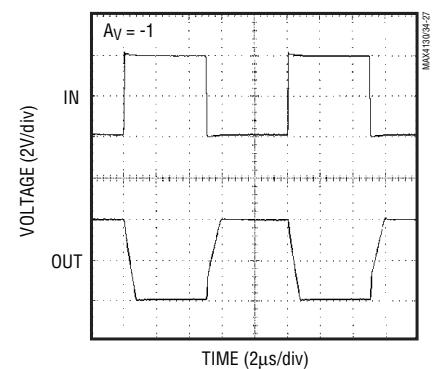
**MAX4131
SMALL-SIGNAL TRANSIENT
RESPONSE (INVERTING)**



**MAX4131
LARGE-SIGNAL TRANSIENT
RESPONSE (NONINVERTING)**



**MAX4131
LARGE-SIGNAL TRANSIENT
RESPONSE (INVERTING)**



Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Pin Description

PIN						NAME	FUNCTION
MAX4130	MAX4131		MAX4132	MAX4133	MAX4134		
	SO/μMAX	UCSP					
1	6	A2	—	—	—	OUT	Output
2	4	A1	4	4	11	V _{EE}	Negative Supply. Connect to GND for single-supply operation.
3	3	B1	—	—	—	IN+	Noninverting Input
4	2	B2	—	—	—	IN-	Inverting Input
5	7	A3	8	14	4	V _{CC}	Positive Supply
—	1, 5	—	—	5, 7, 8, 10	—	N.C.	No Connection. Not internally connected.
—	8	B3	—	—	—	$\overline{\text{SHDN}}$	Shutdown Control. Connect to V _{CC} or leave floating to enable amplifier.
—	—	—	1, 7	1, 13	1, 7	OUT1, OUT2	Outputs for Amps 1 and 2
—	—	—	2, 6	2, 12	2, 6	IN1-, IN2-	Inverting Inputs for Amps 1 and 2
—	—	—	3, 5	3, 11	3, 5	IN1+, IN2+	Noninverting Inputs for Amps 1 and 2
—	—	—	—	6, 9	—	$\overline{\text{SHDN1}}$, $\overline{\text{SHDN2}}$	Shutdown Control. Provides independent shutdown control for amps 1 and 2. Connect to V _{CC} or leave floating to enable amplifiers.
—	—	—	—	—	8, 14	OUT3, OUT4	Outputs for Amps 3 and 4
—	—	—	—	—	9, 13	IN3-, IN4-	Inverting Inputs for Amps 3 and 4
—	—	—	—	—	10, 12	IN3+, IN4+	Noninverting Inputs for Amps 3 and 4

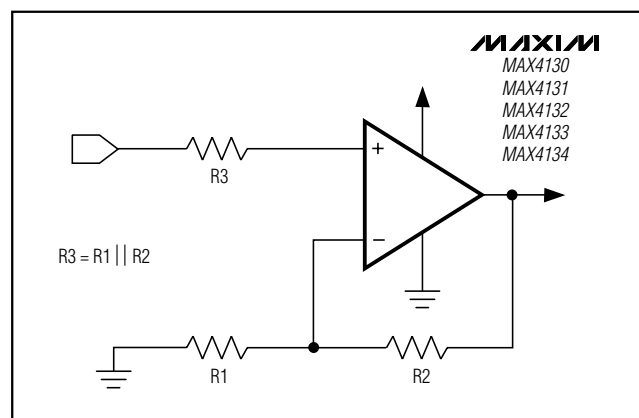


Figure 1a. Reducing Offset Error Due to Bias Current (Noninverting)

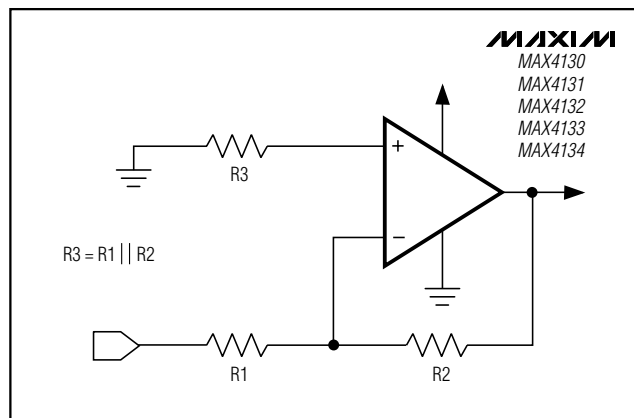


Figure 1b. Reducing Offset Error Due to Bias Current (Inverting)

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Applications Information

Rail-to-Rail Input Stage

Devices in the MAX4130–MAX4134 family of high-speed amplifiers have rail-to-rail input and output stages designed for low-voltage, single-supply operation. The input stage consists of separate NPN and PNP differential stages that combine to provide an input common-mode range that extends 0.2V beyond the supply rails. The PNP stage is active for input voltages close to the negative rail, and the NPN stage is active for input voltages near the positive rail. The input offset voltage is typically below 200μV. The switchover transition region, which occurs near $V_{CC} / 2$, has been extended to minimize the slight degradation in common-mode rejection ratio caused by the mismatch of the input pairs. Their low offset voltage, high bandwidth, and rail-to-rail common-mode range make these op amps excellent choices for precision, low-voltage data-acquisition systems.

Since the input stage switches between the NPN and PNP pairs, the input bias current changes polarity as the input voltage passes through the transition region.

Reduce the offset error caused by input bias currents flowing through external source impedances by matching the effective impedance seen by each input (Figures 1a, 1b). High source impedances, together with input capacitance, can create a parasitic pole that produces an underdamped signal response. Reducing the input impedance or placing a small (2pF to 10pF) capacitor across the feedback resistor improves response.

The MAX4130–MAX4134s' inputs are protected from large differential input voltages by 1kΩ series resistors and back-to-back triple diodes across the inputs (Figure 2). For differential input voltages less than 1.8V, input resistance is typically 500kΩ. For differential input voltages greater than 1.8V, input resistance is approximately 2kΩ. The input bias current is given by the following equation:

$$I_{BIAS} = \frac{V_{DIFF} - 1.8V}{2k\Omega}$$

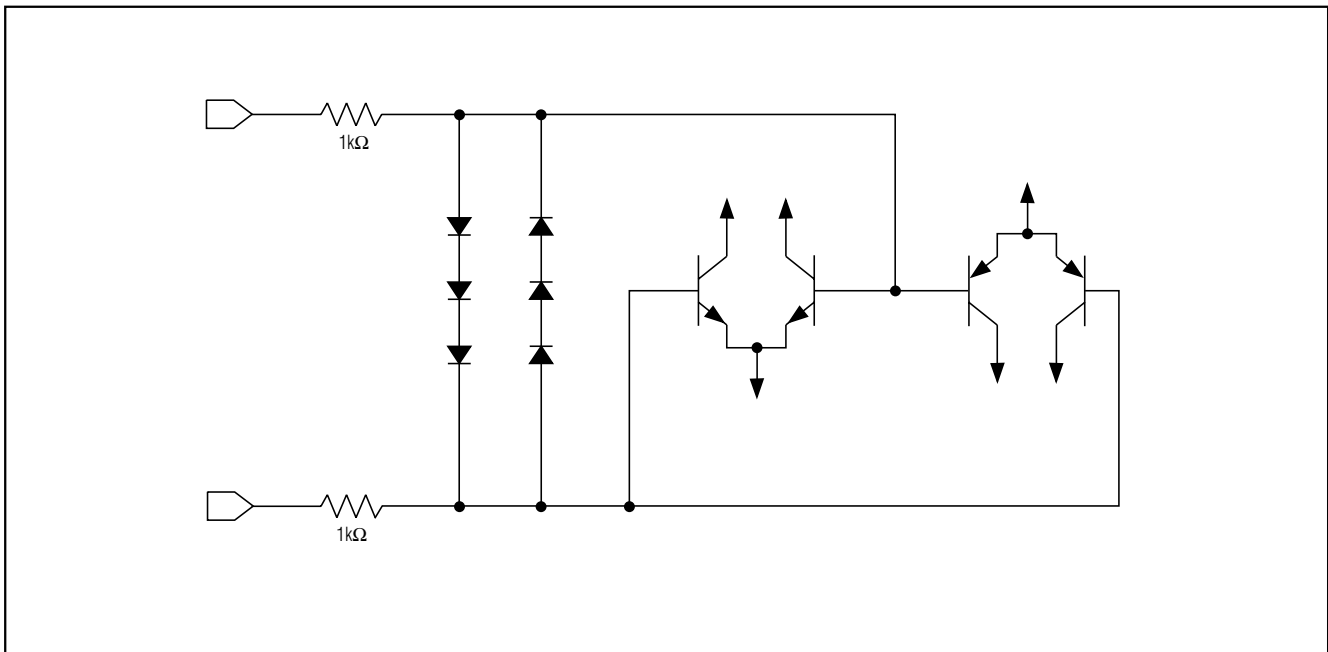


Figure 2. Input Protection Circuit

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Rail-to-Rail Output Stage

The minimum output voltage is within millivolts of ground for single-supply operation where the load is referenced to ground (V_{EE}). Figure 3 shows the input voltage range and output voltage swing of a MAX4131 connected as a voltage follower. With a +3V supply and the load tied to ground, the output swings from 0.00V to 2.90V. The maximum output voltage swing depends on the load, but will be within 150mV of a +3V supply, even with the maximum load (500Ω to ground).

Driving a capacitive load can cause instability in most high-speed op amps, especially those with low quiescent current. The MAX4130-MAX4134 have a high tolerance for capacitive loads. They are stable with capacitive loads up to 160pF. Figure 4 gives the stable operating region for capacitive loads. Figures 5 and 6 show the response with capacitive loads and the results of adding an isolation resistor in series with the output (Figure 7). The resistor improves the circuit's phase margin by isolating the load capacitor from the op amp's output.

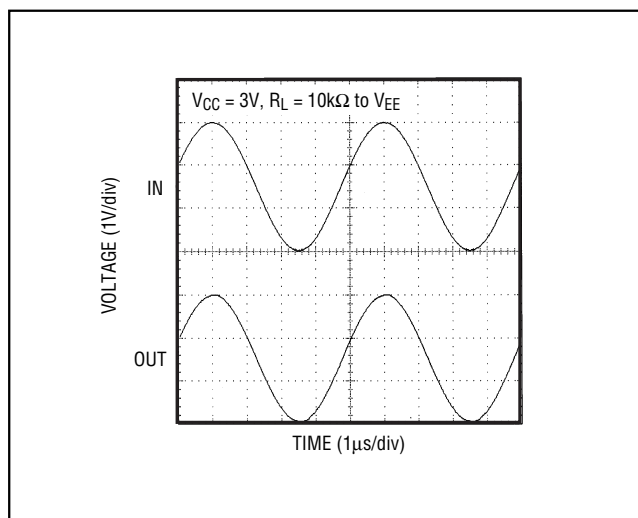


Figure 3. Rail-to-Rail Input/Output Voltage Range

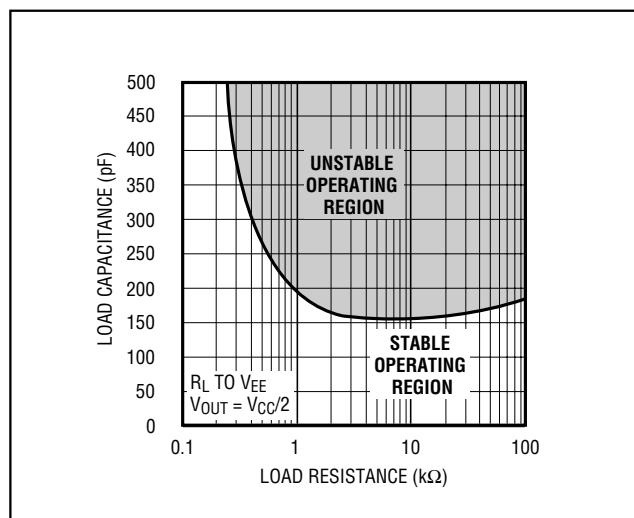


Figure 4. Capacitive-Load Stability

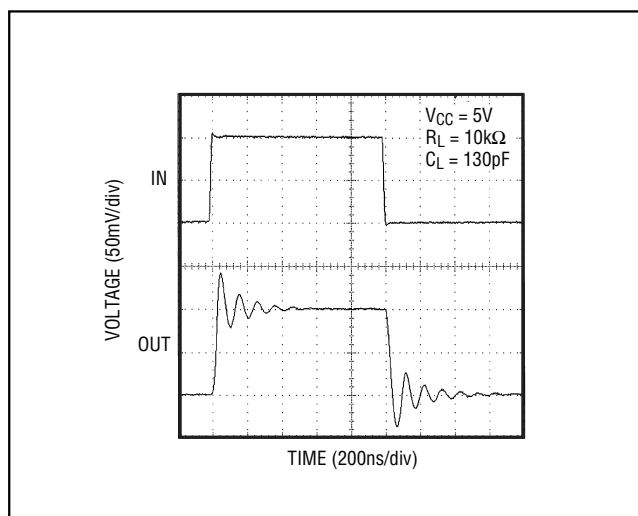


Figure 5. MAX4131 Small-Signal Transient Response with Capacitive Load

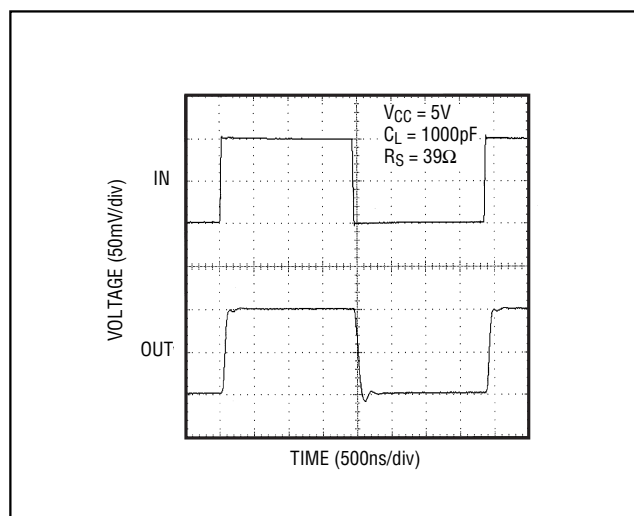


Figure 6. MAX4131 Transient Response to Capacitive Load with Isolation Resistor

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Power-Up and Shutdown Mode

The MAX4130–MAX4134 amplifiers typically settle within 1 μ s after power-up. Figures 9 and 10 show the output voltage and supply current on power-up, using the test circuit of Figure 8.

The MAX4131 and MAX4133 have a shutdown option. When the shutdown pin (SHDN) is pulled low, the supply current drops below 25 μ A per amplifier and the

amplifiers are disabled with the outputs in a high-impedance state. Pulling SHDN high or leaving it floating enables the amplifier. In the dual-amplifier MAX4133, the shutdown functions operate independently. Figures 11 and 12 show the output voltage and supply current responses of the MAX4131 to a shutdown pulse, using the test circuit of Figure 8.

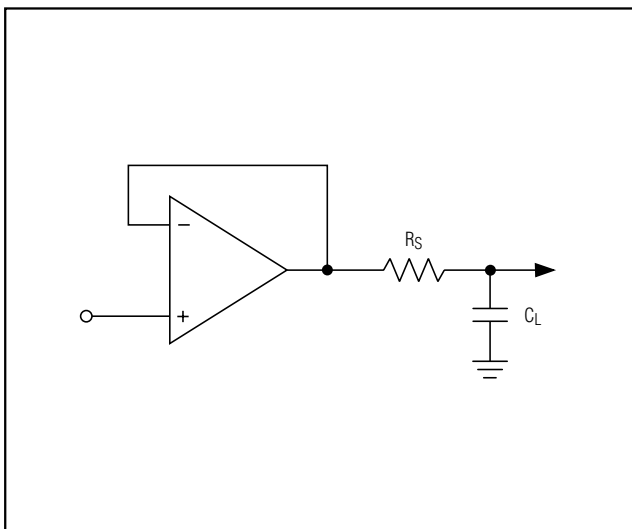


Figure 7. Capacitive-Load Driving Circuit

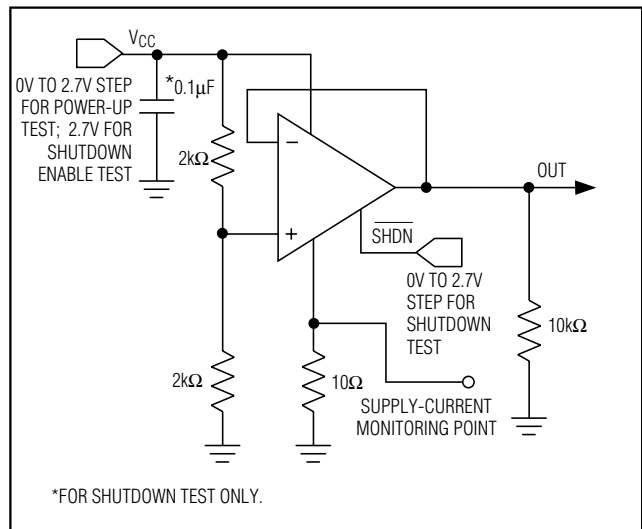


Figure 8. Power-Up/Shutdown Test Circuit

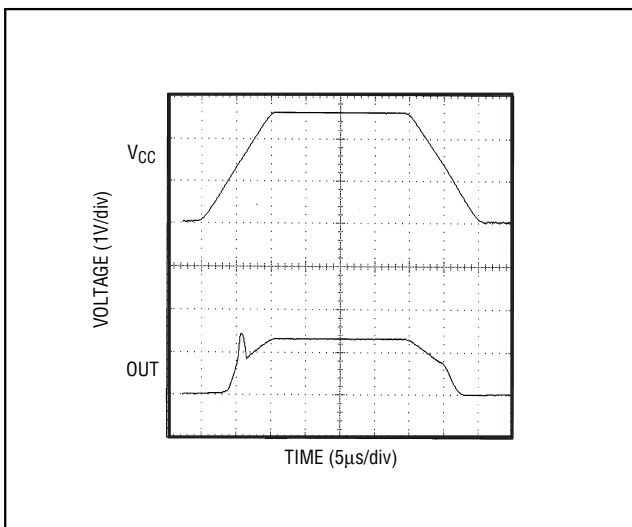


Figure 9. Power-Up Output Voltage

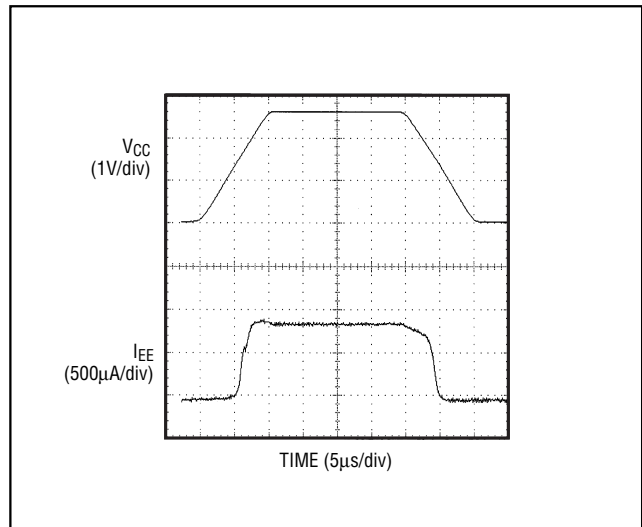


Figure 10. Power-Up Supply Current

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

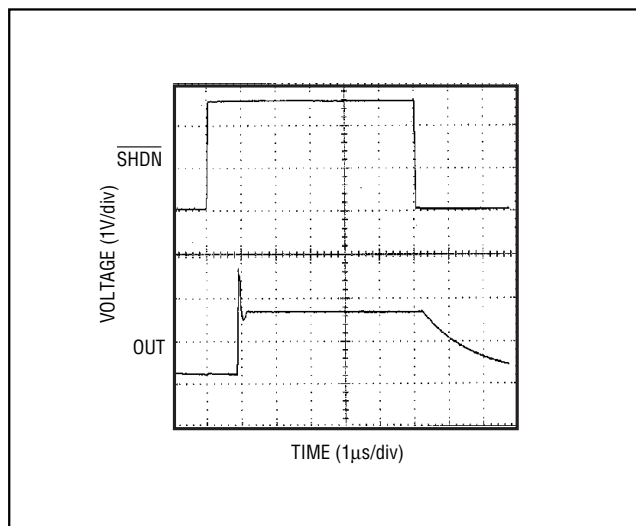


Figure 11. Shutdown Output Voltage

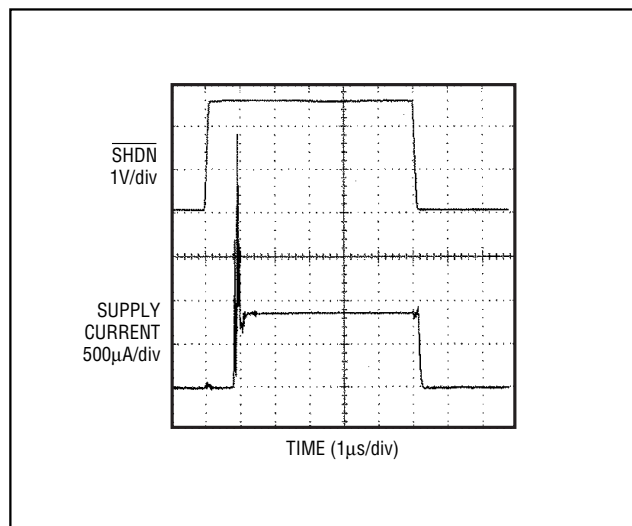


Figure 12. Shutdown Enable/Disable Supply Current

Power Supplies and Layout

The MAX4130-MAX4134 operate from a single +2.7V to +6.5V power supply, or from dual supplies of $\pm 1.35\text{V}$ to $\pm 3.25\text{V}$. For single-supply operation, bypass the power supply with a $0.1\mu\text{F}$ ceramic capacitor in parallel with at least $1\mu\text{F}$. For dual supplies, bypass each supply to ground.

Good layout improves performance by decreasing the amount of stray capacitance at the op amp's inputs and outputs. Decrease stray capacitance by placing external components close to the op amp's pins, minimizing trace lengths and resistor leads.

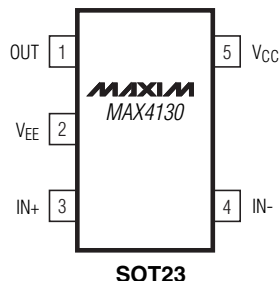
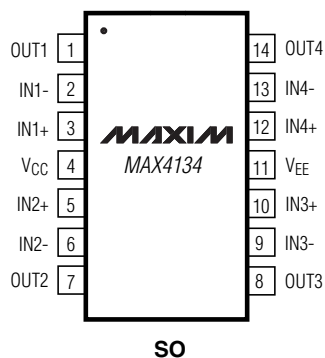
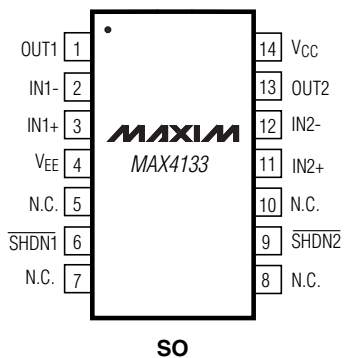
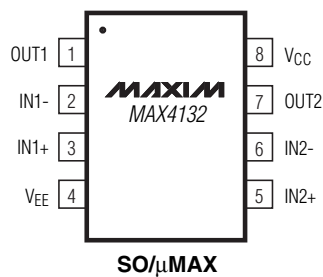
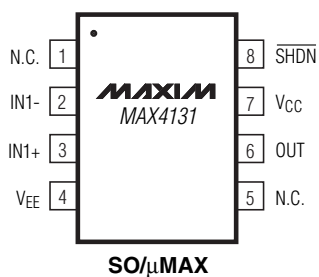
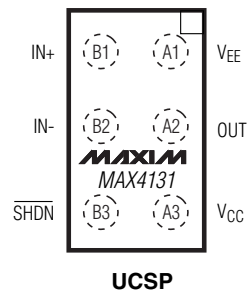
UCSP Applications Information

For the latest application details on UCSP construction, dimensions, tape carrier information, PC board techniques, bump-pad layout, and the recommended reflow temperature profile, as well as the latest information on reliability testing results, go to Maxim's website at www.maxim-ic.com/ucsp and search for the Application Note: *UCSP-A Wafer-Level Chip-Scale Package*.

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Pin Configurations

TOP VIEW

TOP VIEW
BUMPS ON BOTTOM

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX4132ESA	-40°C to +85°C	8 SO	—
MAX4132EUA	-40°C to +85°C	8 μ MAX	—
MAX4133C/D	0°C to +70°C	Dice*	—
MAX4133ESD	-40°C to +85°C	14 SO	—
MAX4134ESD	-40°C to +85°C	14 SO	—

*Dice are specified at $T_A = +25^\circ\text{C}$, DC parameters only.

Chip Information

MAX4130 TRANSISTOR COUNT: 170

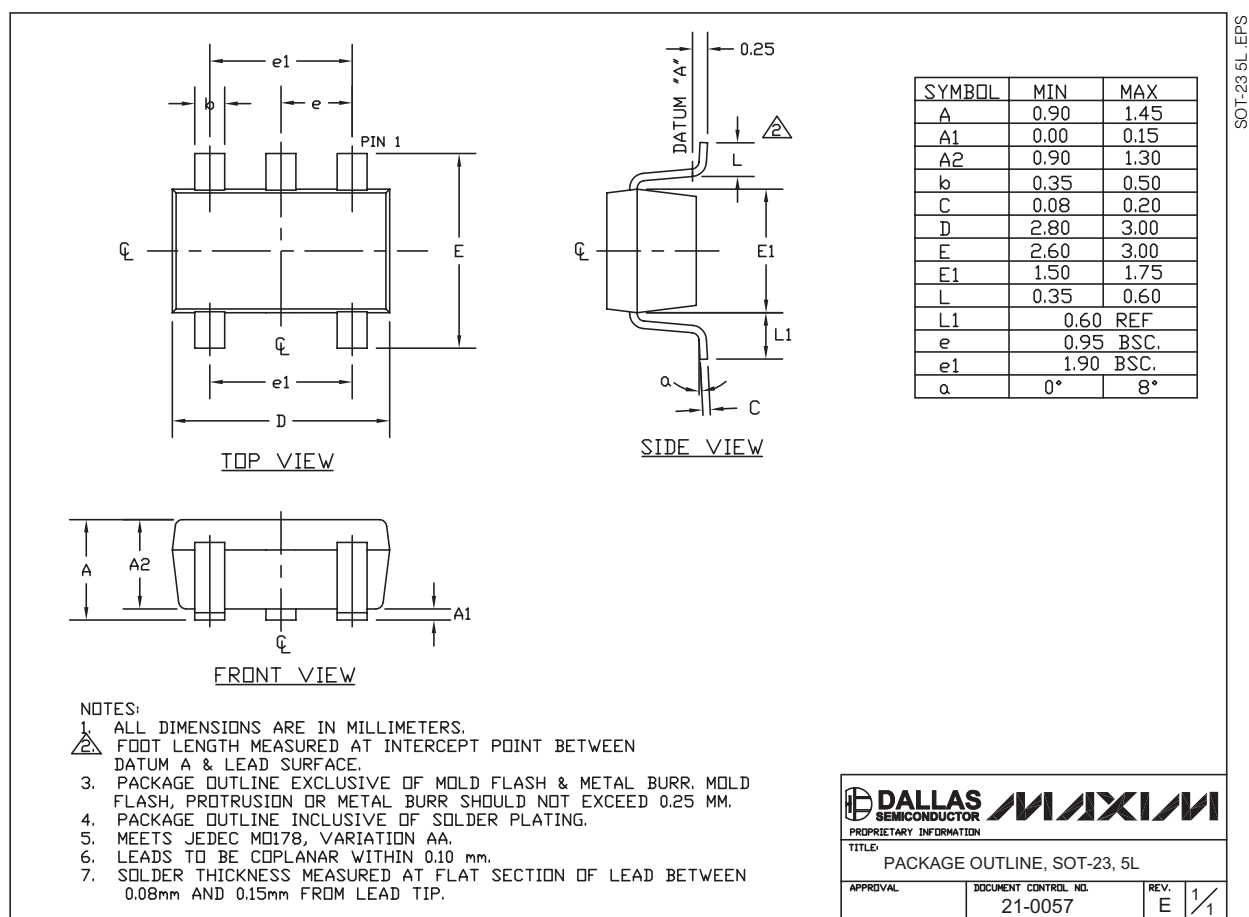
MAX4131 TRANSISTOR COUNT: 170

MAX4132 TRANSISTOR COUNT: 340

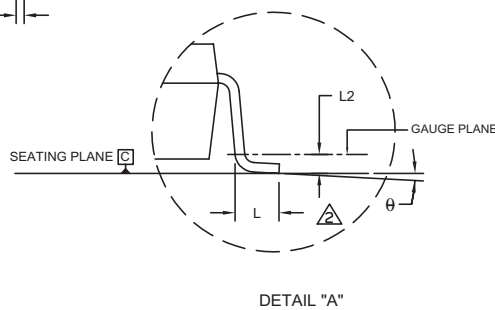
MAX4134 TRANSISTOR COUNT: 680

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



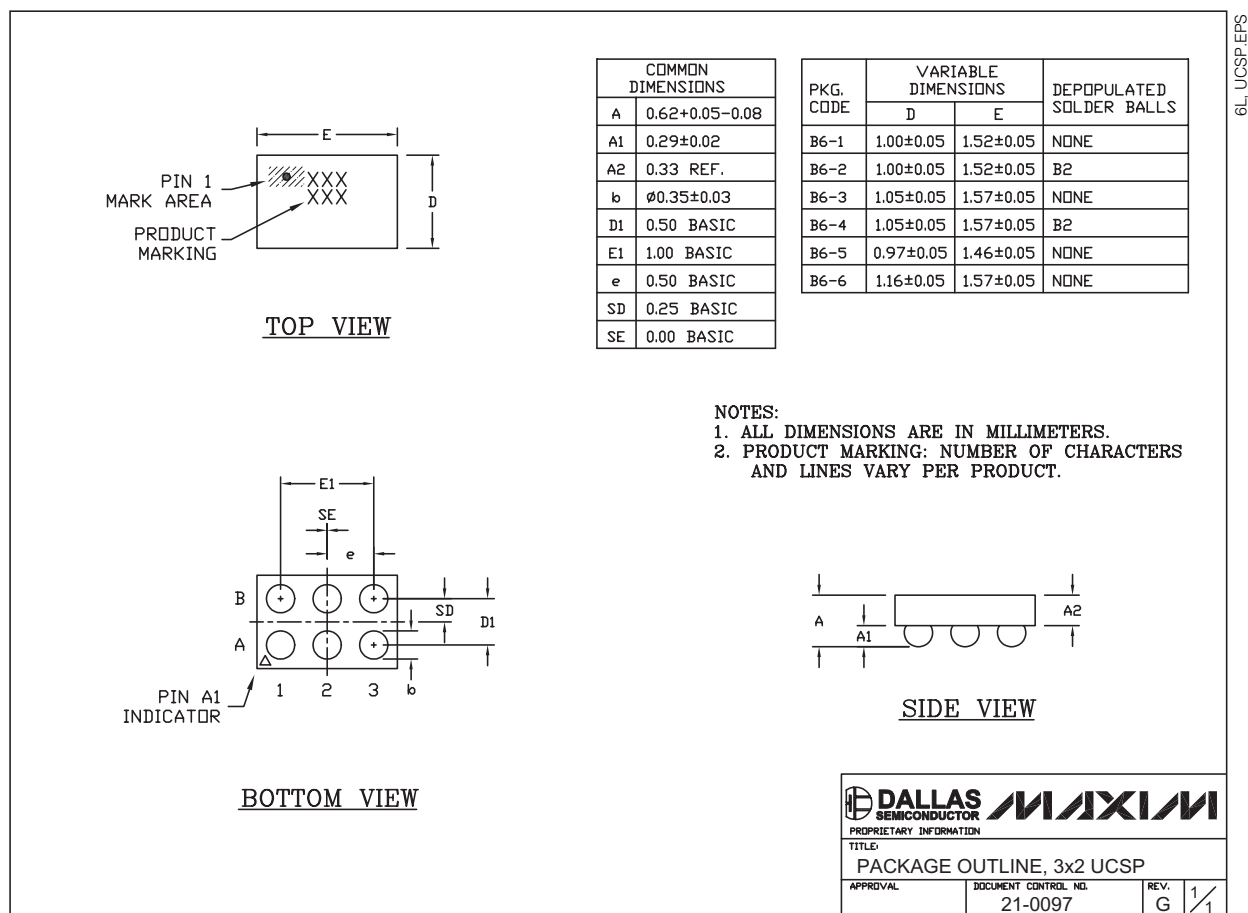
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. FOOT LENGTH MEASURED FROM LEAD TIP TO UPPER RADIUS OF HEEL OF THE LEAD PARALLEL TO SEATING PLANE C.
3. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & METAL BURR.
4. PACKAGE OUTLINE INCLUSIVE OF SOLDER PLATING.
5. COPLANARITY 4 MILS. MAX.
6. PIN 1 I.D. DOT IS 0.3 MM MIN. LOCATED ABOVE PIN 1.
7. SOLDER THICKNESS MEASURED AT FLAT SECTION OF LEAD BETWEEN 0.08mm AND 0.15mm FROM LEAD TIP.
8. MEETS JEDEC MO178.

SOT23, 8L.EPS

Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Package Information (continued)

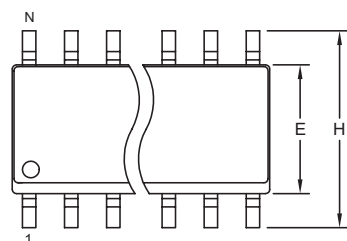
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



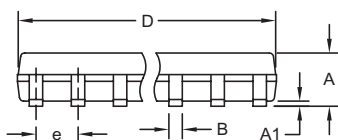
Single/Dual/Quad, Wide-Bandwidth, Low-Power, Single-Supply, Rail-to-Rail I/O Op Amps

Package Information (continued)

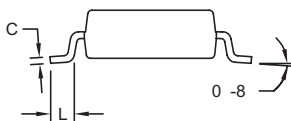
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



TOP VIEW



FRONT VIEW



SIDE VIEW

NOTES:

1. D & E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS012.
6. N = NUMBER OF PINS.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050 BSC		1.27 BSC	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27

VARIATIONS:

DIM	INCHES		MILLIMETERS		N	MS012
	MIN	MAX	MIN	MAX		
D	0.189	0.197	4.80	5.00	8	AA
D	0.337	0.344	8.55	8.75	14	AB
D	0.386	0.394	9.80	10.00	16	AC

 DALLAS SEMICONDUCTOR			
PROPRIETARY INFORMATION			
TITLE:			
PACKAGE OUTLINE, .150" SOIC			
APPROVAL	DOCUMENT CONTROL NO.	REV.	1/
	21-0041	B	

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

18 **Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 (408) 737-7600**